


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	MDG/17/10011	
1.3 Title of PCN	Transfer assembly plant from Stats ChipPAC Shanghai China (SCC) to Stats ChipPAC Jiangyin China (JSCC) for STM32L44x 256KB & STM32L46x 512KB & STM32L4Ax 1MB & STM32L4x 1MB products in LQFP packages	
1.4 Product Category	STM32L44x 256KB & STM32L46x 512KB & STM32L4Ax 1MB & STM32L4x 1MB product sub families in LQFP 64 10x10x1.4 & LQFP 64 10x10x1.4 packages	
1.5 Issue date	2017-03-10	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	MARSHALL DAVE
2.1.2 Phone	
2.1.3 Email	dave.marshall@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Michel BUFFA
2.1.2 Marketing Manager	Daniel COLONNA
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Any change on substrate (part number, supplier, plant, design or composition of any layer...)	Stats ChipPAC Shanghai China (SCC), Stats ChipPAC Jiangyin China (JSCC)

4. Description of change

	Old	New
4.1 Description	Current location : Stats ChipPAC Shanghai China (SCC)	Transfer from Stats ChipPAC Shanghai China (SCC) to Stats ChipPAC Jiangyin China (JSCC) location. See more information on PCN 10011 – Additional information document attached.
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No change	

5. Reason / motivation for change

5.1 Motivation	Due to Shanghai China site closure, production is relocated to Jiangyin China site. This Product Change Notification (PCN) concerns only STM32L44x 256KB & STM32L46x 512KB & STM32L4Ax 1MB & STM32L4x 1MB product sub families in LQFP packages.
5.2 Customer Benefit	SERVICE CONTINUITY

6. Marking of parts / traceability of change

6.1 Description	Traceability is described in PCN10011_Additional information attached document
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7. Timing / schedule

7.1 Date of qualification results	2017-05-19
7.2 Intended start of delivery	2017-06-19
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	10011 PCN9976_PCN10011_RERMCD1621- LQFP JSCC- MCD QA reliability plan.pdf
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8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2017-03-10
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9. Attachments (additional documentations)	
10011 Public product.pdf 10011 PCN10011_Additional information.pdf 10011 PCN9976_PCN10011_RERMCD1621- LQFP JSCC- MCD QA reliability plan.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
2518170	STM32L476RCT6	
2494459	STM32L476RET6	
2494460	STM32L476RGT6	
2494466	STM32L486RGT6	
2725138	STM32L496RGT6	

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